# 74AHC2G08; 74AHCT2G08

# **Dual 2-input AND gate**

Rev. 5 — 27 November 2013

**Product data sheet** 

# 1. General description

The 74AHC2G08; 74AHCT2G08 is a high-speed Si-gate CMOS device.

The 74AHC2G08; 74AHCT2G08 provides two 2-input AND gates.

#### 2. Features and benefits

- Symmetrical output impedance
- High noise immunity
- ESD protection:
  - HBM JESD22-A114E exceeds 2000 V
  - MM JESD22-A115-A exceeds 200 V
  - CDM JESD22-C101C exceeds 1000 V
- Low power dissipation
- Balanced propagation delays
- Multiple package options
- Specified from -40 °C to +80 °C and from -40 °C to +125 °C

# 3. Ordering information

Table 1. Ordering information

Type number	Package			
	Temperature range	Name   Name	Description	Version
74AHC2G08DP	-40 °C to +125 °C	TSSOP8	plastic thin shrink small outline package; 8 leads; body	SOT505-2
74AHCT2G08DP			width 3 mm; lead length 0.5 mm	
74AHC2G08DC	–40 °C to +125 °C	VSSOP8	plastic very thin shrink small outline package; 8 leads;	SOT765-1
74AHCT2G08DC			body width 2.3 mm	
74AHC2G08GD	–40 °C to +125 °C	XSON8	plastic extremely thin small outline package; no leads;	SOT996-2
74AHCT2G08GD	WW. 100X.		8 terminals; body $3 \times 2 \times 0.5$ mm	





# 4. Marking

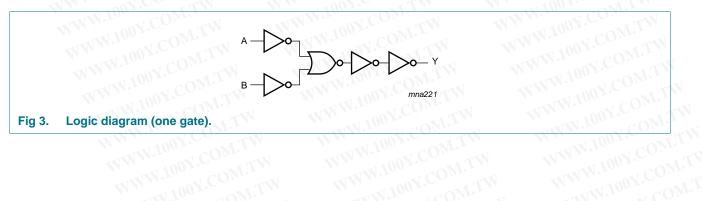
#### Table 2. Marking

Type number	Marking code <sup>[1]</sup>
74AHC2G08DP	A08 WWW.COMM
74AHCT2G08DP	CON CONTRACTOR CONTRAC
74AHC2G08DC	A08 COMPANIES
74AHCT2G08DC	C08
74AHC2G08GD	A08
74AHCT2G08GD	100 J. C08 W. T. C08

<sup>[1]</sup> The pin 1 indicator is located on the lower left corner of the device, below the marking code.

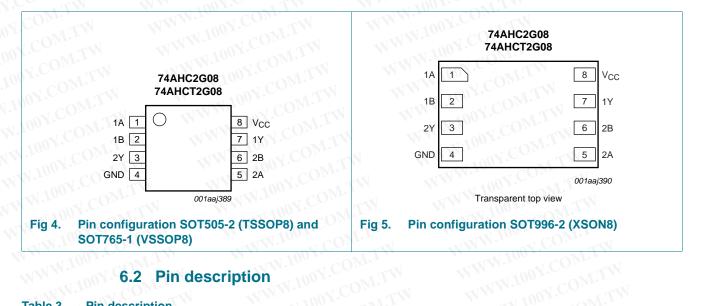
# 5. Functional diagram





# **Pinning information**

#### 6.1 **Pinning**



#### 6.2 Pin description

Pin description Table 3.

	6.2 Pin description	
Table 3. Pi	in description	
Symbol	OOY Pin	Description
1A, 2A	1,5	data input
1B, 2B	2, 6	data input
GND	4 V.COM TW WWW	ground (0 V)
1Y, 2Y	7,3	data output
V <sub>CC</sub>	NW-8 COM-	supply voltage
- 14	27N.100 COM. 1	M. Ing y. COM. T. COM. Y.

# **Functional description**

Function table[1] Table 4.

Input	TOOY.CO. TY WIN	Output
nA NV	nB nB	nY
L	W.In COM.	WW. COLL TW WWW. 100X.CO.
L	WW.100 Y CHILL	IMM' Ing COM' TAN MMM' I OW' CO
Н	21.M.100 2. COM: 1	MW.100 CDM.1
H	HOM.37	HOM.1

<sup>[1]</sup> H = HIGH voltage level; L = LOW voltage level. WWW.100Y.COM.TW WWW.100

# 8. Limiting values

Table 5. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	Min	Max	Unit
V <sub>CC</sub>	supply voltage		-0.5	+7.0	V
VI	input voltage	Y.COMITH WWW.100	-0.5	+7.0	V
I <sub>IK</sub>	input clamping current	V <sub>I</sub> < −0.5 V	<u>[1]</u> –20	-	mA
I <sub>OK</sub>	output clamping current	$V_{O} < -0.5 \text{ V or } V_{O} > V_{CC} + 0.5 \text{ V}$	<u> </u>	±20	mA
lo CO	output current	$-0.5 \text{ V} < \text{V}_{\text{O}} < \text{V}_{\text{CC}} + 0.5 \text{ V}$	100 Y.Co	±25	mA
Icc	supply current		100X.C.	75	mA
I <sub>GND</sub>	ground current		-75	TT	mA
$T_{stg}$	storage temperature		-65	+150	°C
P <sub>tot</sub>	total power dissipation	$T_{amb} = -40  ^{\circ}\text{C} \text{ to } +125  ^{\circ}\text{C}$	[2] - [0]	250	mW

<sup>[1]</sup> The input and output voltage ratings may be exceeded if the input and output current ratings are observed.

# 9. Recommended operating conditions

Table 6. Recommended operating conditions

Voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	C74	AHC2G	08	74	AHCT2G	808	Unit
	WW.100 F COM	. WWW.	Min	Тур	Max	Min	Тур	Max	WT
V <sub>CC</sub>	supply voltage	V. T. V.	2.0	5.0	5.5	4.5	5.0	5.5	٧
VI	input voltage	W.LA.	1.10	COM.	5.5	0	W.V.	5.5	V
Vo	output voltage	ON.TW WY	00	MOD	V <sub>CC</sub>	0	W.	V <sub>CC</sub>	V
T <sub>amb</sub>	ambient temperature	M.TW WY	-40	+25	+125	-40	+25	+125	°C
Δt/ΔV	input transition rise	$V_{CC}$ = 3.3 V $\pm$ 0.3 V	VI 10	OY.CO	100	-	MA	N 100 Y	ns/V
	and fall rate	$V_{CC} = 5.0 \text{ V} \pm 0.5 \text{ V}$	M. M.	ONLC'	20	-	WW	20	ns/V

<sup>[2]</sup> For TSSOP8 package: above 55 °C the value of  $P_{tot}$  derates linearly with 2.5 mW/K. For VSSOP8 package: above 110 °C the value of  $P_{tot}$  derates linearly with 8 mW/K. For XSON8 package: above 45 °C the value of  $P_{tot}$  derates linearly with 2.4 mW/K.

### 10. Static characteristics

Table 7. Static characteristics

Voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions		25 °C	11.10	-40 °C	to +85 °C	-40 °C	to +125 °C	Un
		VVI. 100x. COM.TV	Min	Тур	Max	Min	Max	Min	Max	
74AHC2	G08				TATIVI.			- 1		
$V_{IH}$	HIGH-level	V <sub>CC</sub> = 2.0 V	1.5	- 1	171	1.5	TIMOS	1.5	-	V
	input voltage	V <sub>CC</sub> = 3.0 V	2.1	-	VI W.	2.1	M. OM.	2.1	-	V
		V <sub>CC</sub> = 5.5 V	3.85	-	WIN	3.85	A.Co.	3.85	-	٧
V <sub>IL</sub>	LOW-level	V <sub>CC</sub> = 2.0 V	WT	-	0.5	1311-7	0.5	WT	0.5	٧
	input voltage	V <sub>CC</sub> = 3.0 V	Mr.	V-	0.9	M. W.	0.9	TW	0.9	٧
		V <sub>CC</sub> = 5.5 V	$\overline{M_{1}}$	<n< td=""><td>1.65</td><td>WW.</td><td>1.65</td><td>)<u>I</u>VI.,</td><td>1.65</td><td>٧</td></n<>	1.65	WW.	1.65	) <u>I</u> VI.,	1.65	٧
V <sub>OH</sub>	HIGH-level	$V_I = V_{IH}$ or $V_{IL}$	$O_{M,J}$	-31			100 x	OM.		
	output voltage	$I_{O} = -50 \mu A$ ; $V_{CC} = 2.0 \text{ V}$	1.9	2.0	-	1.9	N-100 X	1.9	-	٧
		$I_{O} = -50 \mu A$ ; $V_{CC} = 3.0 \text{ V}$	2.9	3.0	-	2.9	74.100X	2.9	17/	٧
		$I_{O} = -50 \mu A$ ; $V_{CC} = 4.5 V$	4.4	4.5	_	4.4	100	4.4	1.77	٧
		$I_0 = -4.0 \text{ mA}; V_{CC} = 3.0 \text{ V}$	2.58	- T	N	2.48	100	2.40	VETW	٧
		$I_{O} = -8.0 \text{ mA}; V_{CC} = 4.5 \text{ V}$	3.94	) N		3.8	W.	3.70	Wr.	٧
V <sub>OL</sub>	LOW-level	$V_I = V_{IH}$ or $V_{IL}$	~~V.C	OM.			WWW.h	ooy.C	ON. TW	
	output voltage	$I_O = 50 \mu A; V_{CC} = 2.0 \text{ V}$	00 5	0)14	0.1	-	0.1	-0V.C	0.1	٧
		$I_O = 50 \mu\text{A};  V_{CC} = 3.0 \text{V}$	700 x	0 0	0.1	sī <del>-</del>	0.1	700 7	0.1	V
		$I_0 = 50 \mu A; V_{CC} = 4.5 V$	N-100	0	0.1	-	0.1	V-100,	0.1	٧
		$I_O = 4.0 \text{ mA}; V_{CC} = 3.0 \text{ V}$	× 100	N.C.	0.36	<u> </u>	0.44	V.100	0.55	٧
		$I_{O} = 8.0 \text{ mA}; V_{CC} = 4.5 \text{ V}$	-x1 1(	101.C	0.36	LIN	0.44	-N.10	0.55	V
I <sub>I</sub>	input leakage current	V <sub>I</sub> = 5.5 V or GND; V <sub>CC</sub> = 0 V to 5.5 V	N.W.	100X	0.1	WF.	1.0	WW.1	2.0	μA
I <sub>CC</sub>	supply current	$V_I = V_{CC}$ or GND; $I_O = 0$ A; $V_{CC} = 5.5 \text{ V}$	NWW	× 100	1.0	M.TV	10	WW.	40	μA
Cı	input capacitance	100Y.COM.TW	W.	1.5	10	ōM.T	10	MM	10	pF
74AHCT		N.100 Y.COM.T.Y		L.WW	00 2	COM			W.Mo	C
V <sub>IH</sub>	HIGH-level input voltage	$V_{CC} = 4.5 \text{ V to } 5.5 \text{ V}$	2.0	WW	1002	2.0	I.TW	2.0	VFVV.100	٧
$V_{IL}$	LOW-level input voltage	$V_{CC} = 4.5 \text{ V to } 5.5 \text{ V}$	-	NW	8.0	<sup>2√</sup> CO	0.8	-	0.8	٧
V <sub>OH</sub>	HIGH-level	$V_I = V_{IH}$ or $V_{IL}$ ; $V_{CC} = 4.5 \text{ V}$		11	UN.M	21 C	OM		WW.1	UV
011	output voltage	$I_{O} = -50 \mu\text{A}$	4.4	4.5	· - (V) .	4.4	-OM.TW	4.4	- 71111	V
		$I_{O} = -8.0 \text{ mA}$	3.94	- 1		3.8	-OM.T	3.70	- 111	٧
V <sub>OL</sub>	LOW-level	$V_I = V_{IH}$ or $V_{IL}$ ; $V_{CC} = 4.5 \text{ V}$	W		N. Y.	x 100Y	· OM.	W -	1	
01	output voltage	$I_{O} = 50 \mu\text{A}$	TIN	0	0.1	-1 100	0.1	TW	0.1	V
		$I_0 = 8.0 \text{ mA}$	TW	-	0.36	- 10	0.44	W <sub>T</sub> -1	0.55	V
I <sub>I</sub>	input leakage current	V <sub>I</sub> = 5.5 V or GND; V <sub>CC</sub> = 0 V to 5.5 V	M.T.W	-	0.1	WW.10	1.0	-	2.0	μA

74AHC\_AHCT2G08

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Static characteristics ...continued Table 7.

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<b>Table 7.</b> <i>Voltages</i>	0 101110 (011101101	cteristicscontinued to GND (ground = 0 V).							input 7 it is	gut
Symbol	Parameter	Conditions		25 °C	.100	-40 °C	to +85 °C	-40 °C	to +125 °C	Unit
	×1 ×1	NA 100 T. CON'I I	Min	Тур	Max	Min	Max	Min	Max	
Icc	supply current	$V_I = V_{CC}$ or GND; $I_O = 0$ A; $V_{CC} = 5.5 \text{ V}$	-	WW	1.0	00Y.C	10	-	40	μΑ
Δl <sub>CC</sub>	additional supply current	per input pin; $V_I = 3.4 \text{ V}$ ; other inputs at $V_{CC}$ or GND; $I_O = 0 \text{ A}$ ; $V_{CC} = 5.5 \text{ V}$	V -	- 11	1.35	1.100 X.C	1.5	1 <u>.</u>	1.5	mA
Ci	input capacitance	WWW.100X.COM.	LIN LIN	1.5	10	N.1007	10	TW IN	10	pF

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WWW.100X

# 11. Dynamic characteristics

#### Table 8. Dynamic characteristics

Symbol	Parameter	Conditions	V.C		25 °C		-40 °C t	o +85 °C	-40 °C t	o +125 °C	Unit
	ON:	TWW.10		Min	Тур	Max	Min	Max	Min	Max	
<b>74AHC2</b>	G08	LTW WINN.10	)O +		V.r.	<b>\$</b> 1			A COM	TVV	
t <sub>pd</sub>	propagation	nA, nB to nY; see Figure 6	[1]	. c(	$M_{II}$	-1	77		*1 CO1	V. I	
	delay	$V_{CC} = 3.0 \text{ V to } 3.6 \text{ V}$	[2]	N.C.		N.		W.10	03.2	W.T.	
		C <sub>L</sub> = 15 pF		107.0	4.6	8.8	1.0	10.5	0.1.0	12.0	ns
		$C_L = 50 \text{ pF}$	-11	no Y.	6.5	12.3	1.0	14.0	1.0	16.0	ns
		$V_{CC} = 4.5 \text{ V to } 5.5 \text{ V}$	[3]	1007	CO.	VTI		MMAN	100Y.	TI TI	N
		C <sub>L</sub> = 15 pF	MW	.100	3.2	5.9	(1.0	7.0	1.0	8.0	ns
		C <sub>L</sub> = 50 pF		N.In.	4.6	7.9	1.0	9.0	1.0	10.5	ns
$C_{PD}$	power dissipation capacitance	per buffer; $C_L = 50 \text{ pF}$ ; $f_i = 1 \text{ MHz}$ ; $V_I = \text{GND to V}_{CC}$	<u>[4]</u>	MAY J	17	COM	TW	W	MM.10	OX.COM	pF

Dynamic characteristics ... continued Table 8.

Symbol	Parameter	Conditions			25 °C	.10	-40 °C 1	to +85 °C	-40 °C t	to +125 °C	Unit
	\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\	TAM TON TO CONTIL	I .	Min	Тур	Max	Min	Max	Min	Max	
74AHCT	2G08	W. TOOL COME	-31		NA TAN	W.10	T CO				
t <sub>pd</sub>	propagation	nA, nB to nY; see Figure 6	[1]								
	delay	$V_{CC} = 4.5 \text{ V to } 5.5 \text{ V}$	[3]			NA TAN	1007	OM.TV			
		C <sub>L</sub> = 15 pF		١.	3.6	6.2	1.0	7.1	1.0	8.0	ns
		C <sub>L</sub> = 50 pF		W-	5.1	7.9	1.0	9.0	1.0	10.5	ns
C <sub>PD</sub>	power dissipation capacitance	per buffer; $C_L = 50 \text{ pF}$ ; $f_i = 1 \text{ MHz}$ ; $V_I = \text{GND to } V_{CC}$	[4]	TW	19	W-W	17V.100	Y.COM	TW LTW	-	pF

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- [1]  $t_{pd}$  is the same as  $t_{PLH}$  and  $t_{PHL}$ .
- [2] Typical values are measured at  $V_{CC} = 3.3 \text{ V}$ .
- Typical values are measured at  $V_{CC} = 5.0 \text{ V}$ .
- $C_{PD}$  is used to determine the dynamic power dissipation ( $P_D$  in  $\mu W$ ).

WWW.100Y.COM.TW  $P_D = C_{PD} \times V_{CC}^2 \times f_i \times N + \Sigma (C_L \times V_{CC}^2 \times f_o) \text{ where:}$ 

f<sub>i</sub> = input frequency in MHz;

fo = output frequency in MHz;

C<sub>L</sub> = output load capacitance in pF;

V<sub>CC</sub> = supply voltage in V;

N = number of inputs switching;

 $\Sigma(C_L \times V_{CC}^2 \times f_0)$  = sum of the outputs.

### 12. Waveforms

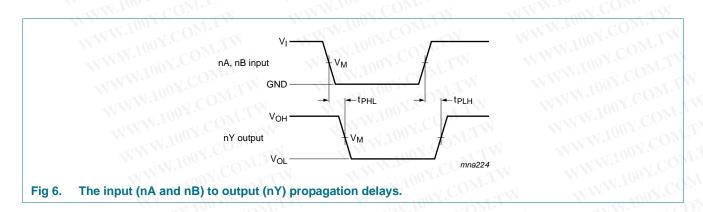
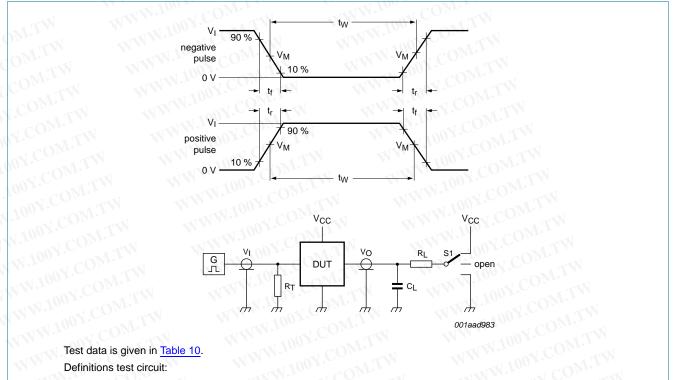


Table 9. Measurement points

Туре	Input	Output	
	V <sub>M</sub>	V <sub>M</sub> (00)	WW.1007
74AHC2G08	0.5V <sub>CC</sub>	0.5V <sub>CC</sub>	
74AHCT2G08	1.5 V	0.5V <sub>CC</sub>	



 $R_T$  = Termination resistance should be equal to output impedance  $Z_o$  of the pulse generator.

C<sub>L</sub> = Load capacitance including jig and probe capacitance.

R<sub>I</sub> = Load resistance.

S1 = Test selection switch.

Test circuit for measuring switching times

Table 10. Test data

Туре	Input	COMPAN	Load	Your	S1 position	M.M.	100 Y. CO.
	VI	t <sub>r</sub> , t <sub>f</sub>	C <sub>L</sub>	R <sub>L</sub>	t <sub>PHL</sub> , t <sub>PLH</sub>	t <sub>PZH</sub> , t <sub>PHZ</sub>	t <sub>PZL</sub> , t <sub>PLZ</sub>
74AHC2G08	$V_{CC}$	≤ 3 ns	15 pF, 50 pF	1 kΩ	open	GND	V <sub>CC</sub>
74AHCT2G08	3 V	≤ 3 ns	15 pF, 50 pF	1 kΩ	open	GND	V <sub>cc</sub>

# 13. Package outline

TSSOP8: plastic thin shrink small outline package; 8 leads; body width 3 mm; lead length 0.5 mm SOT505-2

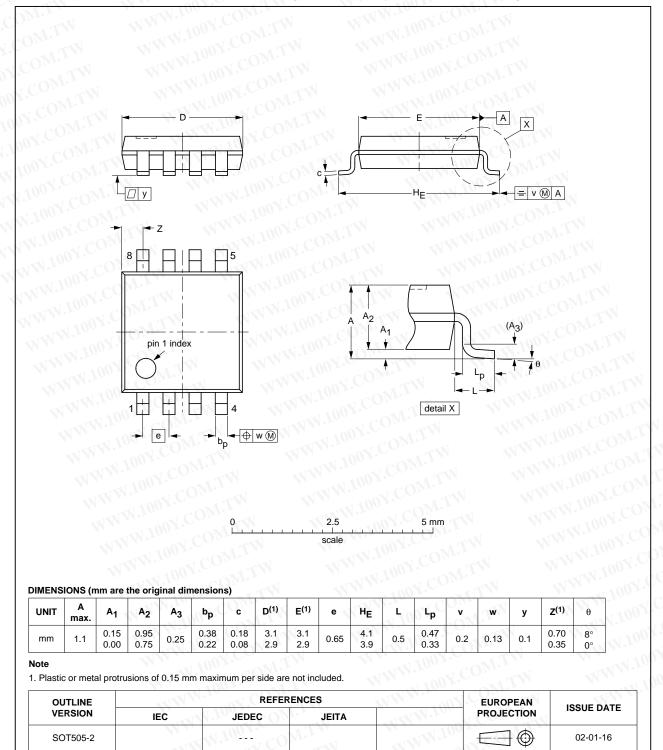
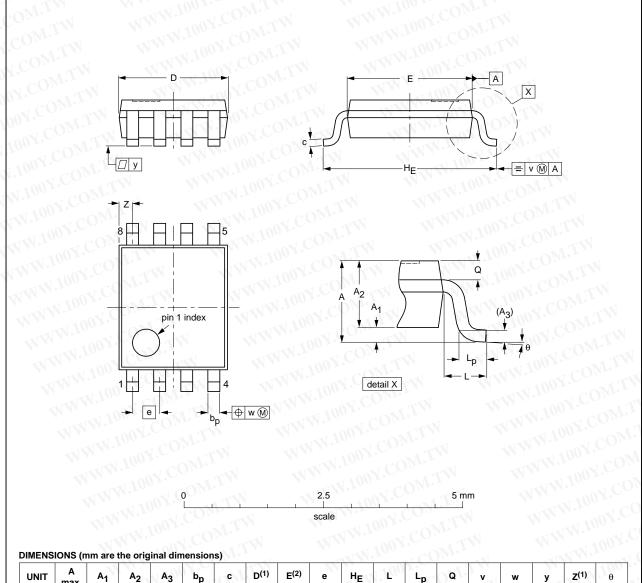


Fig 8. Package outline SOT505-2 (TSSOP8)

74AHC\_AHCT2G08

#### VSSOP8: plastic very thin shrink small outline package; 8 leads; body width 2.3 mm

SOT765-1



UNIT	A max.	A <sub>1</sub>	A <sub>2</sub>	A <sub>3</sub>	bp	c/	D <sup>(1)</sup>	E <sup>(2)</sup>	е	HE	(.100	Lp	Q	v	w	у	Z <sup>(1)</sup>	θ
mm	1	0.15 0.00	0.85 0.60	0.12	0.27 0.17	0.23 0.08	2.1 1.9	2.4 2.2	0.5	3.2 3.0	0.4	0.40 0.15	0.21 0.19	0.2	0.13	0.1	0.4 0.1	8° 0°

#### Notes

- 1. Plastic or metal protrusions of 0.15 mm maximum per side are not included.
- 2. Plastic or metal protrusions of 0.25 mm maximum per side are not included.

OUTLINE		REFERE	EUROPEAN	ISSUE DATE			
VERSION	IEC	JEDEC	JEITA	TIMM.Inc	PROJECTION	ISSUE DATE	
SOT765-1		MO-187		MMM.10		02-06-07	

Fig 9. Package outline SOT765-1 (VSSOP8)

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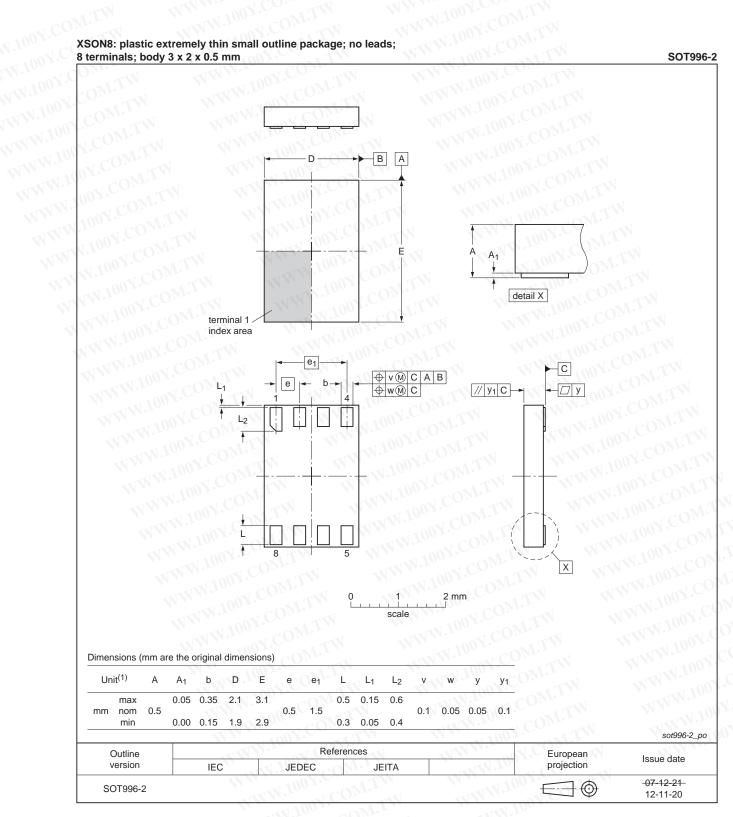


Fig 10. Package outline SOT996-2 (XSON8)

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# .100Y.COM.TW 14. Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes
74AHC_AHCT2G08 v.5	20131127	Product data sheet	TV.COM	74AHC_AHCT2G
Modifications:	General des	scription updated (errata).		
74AHC_AHCT2G08 v.4	20130513	Product data sheet	M. Jon COM.	74AHC_AHCT2G
Modifications:	<ul> <li>For type null</li> </ul>	mber 74AHC2G08GD and 74	4AHCT2G08GD XSON	N8U has changed to
74AHC_AHCT2G08 v.3	20090112	Product data sheet	100 T. COM	74AHC_AHCT2G
74AHC_AHCT2G08 v.2	20041018	Product data sheet	100Y.	74AHC_AHCT2G
74AHC AHCT2G08 v.1	20040206	Product specification	MM-11007.00	T.T.

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# 15. Legal information

#### 15.1 Data sheet status

Document status[1][2]	Product status[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

- [1] Please consult the most recently issued document before initiating or completing a design.
- [2] The term 'short data sheet' is explained in section "Definitions"
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#### **NXP Semiconductors**

**Dual 2-input AND gate** 

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